N and P-Channel Enhancement Mode Power MOSFET

Description

The NCE4606A uses advanced trench technology to provide excellent $R_{DS(ON)}$ and low gate charge . The complementary MOSFETs may be used to form a level shifted high side switch, and for a host of other applications.

General Features

N-Channel

 $V_{DS} = 30V, I_{D} = 6.5A$

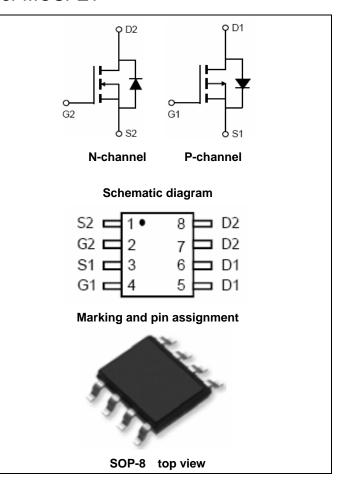
 $R_{DS(ON)}$ < 30m Ω @ V_{GS} =10V

P-Channel

 $V_{DS} = -30V, I_{D} = -7A$

 $R_{DS(ON)}$ < 33m Ω @ V_{GS} =-10V

- High power and current handing capability
- Lead free product is acquired
- Surface mount package



Package Marking and Ordering Information

Device Marking De		Device	Device Package	Reel Size	Tape width	Quantity
	NCE4606A	NCE4606A	SOP-8	Ø330mm	12mm	2500 units

Absolute Maximum Ratings (T_A=25 ℃unless otherwise noted)

Paramete	Symbol	N-Channel	P-Channel	Unit	
Drain-Source Voltage	V _{DS}	30	-30	V	
Gate-Source Voltage	V _{GS}	±20	±20	V	
Continuous Drain Current	T _A =25°C		6.5	-7	Α
Continuous Drain Current	T _A =70°C	I _D	5.4	-5.8	
Pulsed Drain Current (Note 1)		I _{DM}	30	-30	А
Maximum Power Dissipation T _A =25℃		P _D	2.0	2.0	W
Operating Junction and Storage Ten	T_{J} , T_{STG}	-55 To 150	-55 To 150	$^{\circ}$ C	

Thermal Characteristic

Thermal Resistance,Junction-to-Ambient (Note2)	R _{0JA}	N-Ch	62.5	°C/W
Thermal Resistance, Junction-to-Ambient (Note2)	$R_{\theta JA}$	P-Ch	62.5	°C/W



NCE4606A

N-CH Electrical Characteristics (T_A =25 $^{\circ}$ C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	vn Voltage BV_{DSS} V_{GS} =0V I_D =250 μ A		30	33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =30V,V _{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS},I_{D}=250\mu A$	1	1.6	3	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =6A	-	20	30	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =6A	15	-	-	S
Dynamic Characteristics (Note4)				•		
Input Capacitance	C _{lss}	\/ -15\/\/ -0\/	-	255	-	PF
Output Capacitance	C _{oss}	V_{DS} =15V, V_{GS} =0V, F=1.0MHz	-	45	-	PF
Reverse Transfer Capacitance	C _{rss}	r-1.0ivinz	-	35	-	PF
Switching Characteristics (Note 4)				•		
Turn-on Delay Time	t _{d(on)}		-	4.5	-	nS
Turn-on Rise Time	t _r	V_{DD} =15V, R_L =2.5 Ω	-	2.5	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{GEN} =3 Ω	-	14.5	-	nS
Turn-Off Fall Time	t _f		-	3.5	-	nS
Total Gate Charge	Qg	\/ -45\/ -6A	-	13	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =15V, I_{D} =6A, V_{GS} =10V	-	5.5	-	nC
Gate-Drain Charge	Q _{gd}	v _{GS} -10v	-	3.5	-	nC
Drain-Source Diode Characteristics	· ·			•		
Diode Forward Voltage (Note 3)	V _{SD}	V_{GS} =0 V , I_{S} =6 A	-	8.0	1.2	V



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P-CH Electrical Characteristics (T_A=25 ℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	<u> </u>					
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =-250µA		-33	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-30V,V _{GS} =0V	-	-	-1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
On Characteristics (Note 3)	<u> </u>					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=-250\mu A$	-1.0	-1.4	-1.8	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =-10V, I _D =-6.5A	-	28	33	mΩ
Forward Transconductance	g FS	V _{DS} =-5V,I _D =-6.5A	10	-	-	S
Dynamic Characteristics (Note4)	<u>.</u>					
Input Capacitance	C _{lss}	\/ - 45\/\/ -0\/	-	520	-	PF
Output Capacitance	C _{oss}	V_{DS} =-15V, V_{GS} =0V, F=1.0MHz	-	100	-	PF
Reverse Transfer Capacitance	C _{rss}	Γ-1.UIVIΠZ	-	65	-	PF
Switching Characteristics (Note 4)	<u>.</u>					
Turn-on Delay Time	t _{d(on)}		-	7.5	-	nS
Turn-on Rise Time	t _r	V_{DD} =-15V, R_L =2.3 Ω	-	5.5	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =-10 V , R_{GEN} =6 Ω	-	19	-	nS
Turn-Off Fall Time	t _f		-	7	-	nS
Total Gate Charge	Qg	\/ - 45\/ - 0.50	-	9.2	-	nC
Gate-Source Charge	Q _{gs}	V_{DS} =-15V, I_{D} =-6.5A	-	1.6	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =-10V	-	2.2	-	nC
Drain-Source Diode Characteristics				•		
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =-6.5A	-	-	-1.2	V

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production

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N- Channel Typical Electrical and Thermal Characteristics (Curves)

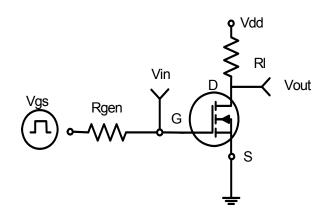


Figure 1:Switching Test Circuit

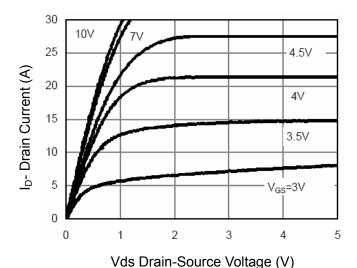


Figure 3 Output Characteristics

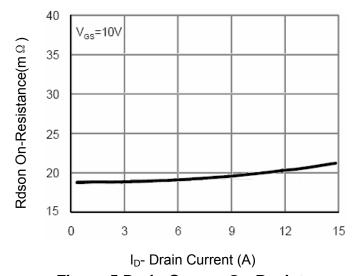


Figure 5 Drain-Source On-Resistance

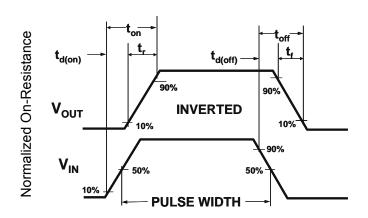


Figure 2:Switching Waveforms

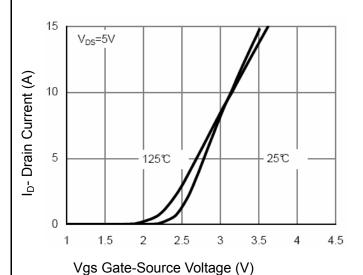


Figure 4 Transfer Characteristics

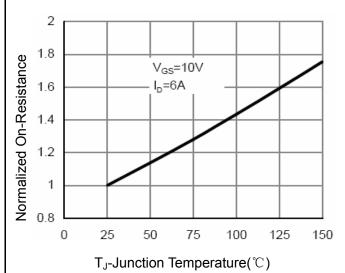


Figure 6 Drain-Source On-Resistance



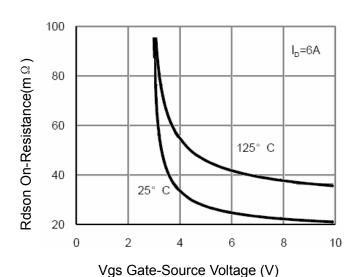


Figure7 Rdson vs Vgs

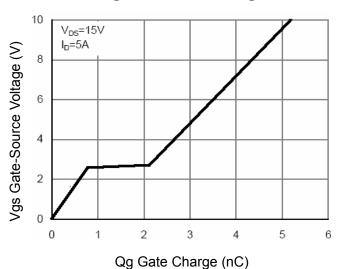


Figure 9 Gate Charge

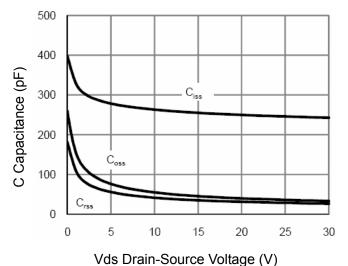
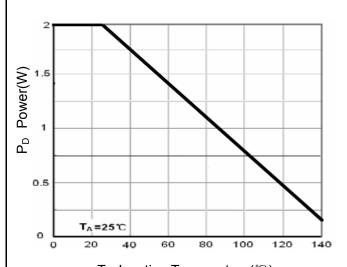


Figure 11 Capacitance vs Vds



 T_J -Junction Temperature($^{\circ}$ C) Figure 8 Power Dissipation

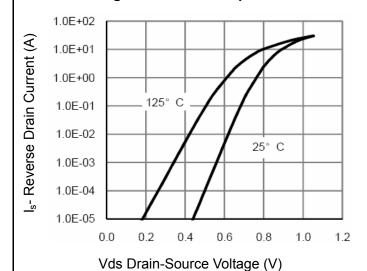
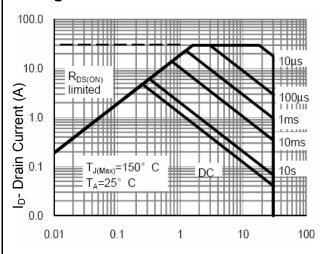


Figure 10 Source- Drain Diode Forward



Vds Drain-Source Voltage (V)
Figure 12 Safe Operation Area



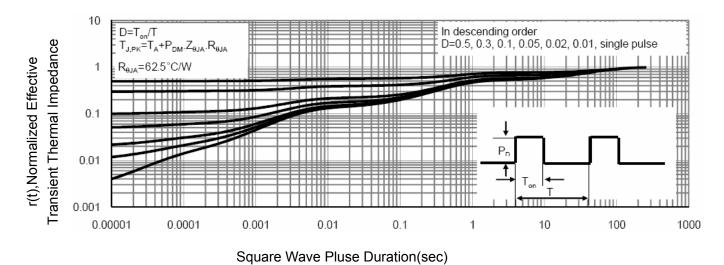


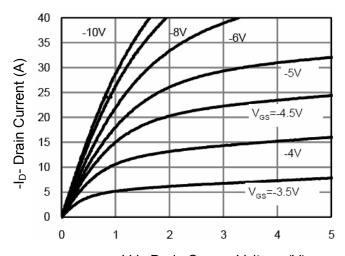
Figure 13 Normalized Maximum Transient Thermal Impedance

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NCE4606A

P- Channel Typical Electrical and Thermal Characteristics (Curves)



-Vds Drain-Source Voltage (V) **Figure 1 Output Characteristics**

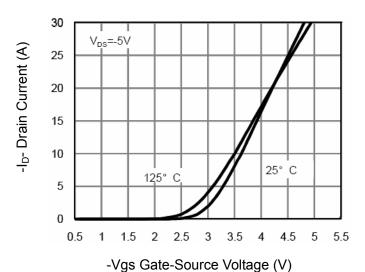


Figure 2 Transfer Characteristics

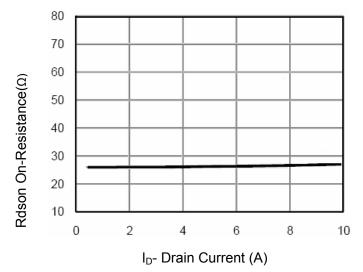


Figure 3 Rdson- Drain Current

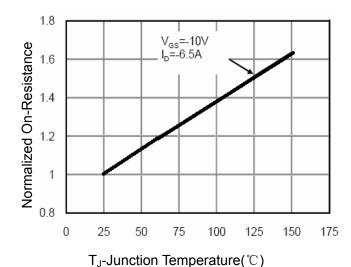


Figure 4 Rdson-Junction Temperature

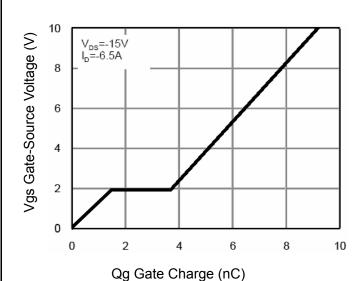


Figure 5 Gate Charge

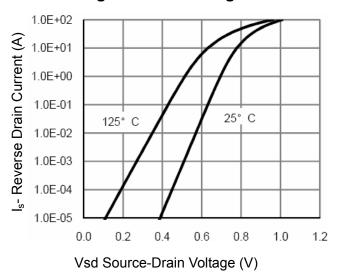


Figure 6 Source- Drain Diode Forward

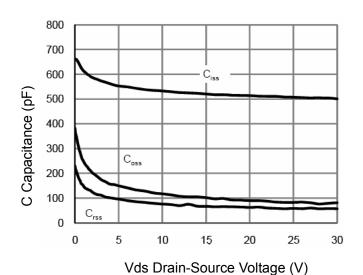
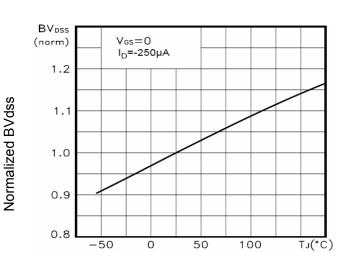


Figure 7 Capacitance vs Vds

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 T_J -Junction Temperature (°C) Figure 9 BV_{DSS} vs Junction Temperature

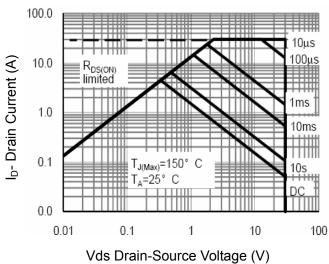


Figure 8 Safe Operation Area

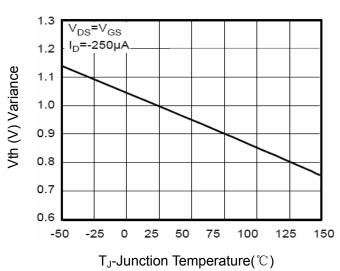


Figure 10 V_{GS(th)} vs Junction Temperature

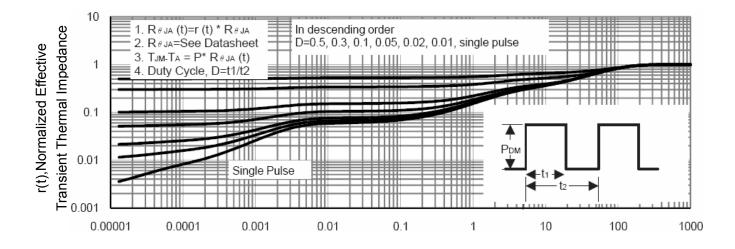


Figure 11 Normalized Maximum Transient Thermal Impedance

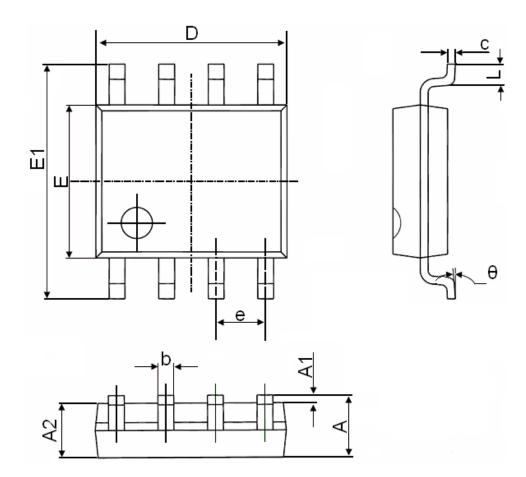
Square Wave Pluse Duration(sec)

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NCE4606A

SOP-8 Package Information



Cumbal	Dimensions I	n Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	1.350	1.750	0.053	0.069	
A1	0.100	0.250	0.004	0.010	
A2	1.350	1.550	0.053	0.061	
b	0.330	0.510	0.013	0.020	
С	0.170	0.250	0.006	0.010	
D	4.700	5.100	0.185	0.200	
E	3.800	4.000	0.150	0.157	
E1	5.800	6.200	0.228	0.244	
е	1.270	(BSC)	0.050	(BSC)	
L	0.400	1.270	0.016	0.050	
θ	0°	8°	0°	8°	



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